PRODUCT CHANGE NOTICE

DCS/PCN-1095

Contact Date: Mar 11, 2008  Implementation Date: June 9, 2008  Alert Category: Discrete Semiconductor  Alert Type: Alternate Die Sources  PCN #: PCN #: 1095

TITLE
Alternate Discrete Die Sources From CS & FA

IMPACT
None Identified.

DESCRIPTION OF CHANGE
This PCN is to notify customers of qualification for additional source of specific dice in discrete devices currently being produced at our Factory in Shanghai, PRC. The new Wafer Fabs will provide additional capacity and improved delivery time for the products specified in the attachment. Full electrical characterization and high reliability testing including PV, ESD, HHT, HTRB, IOL, Autoclave, TC, and RSH will be completed using the alternate dice to ensure no change to device functionality or data sheet electrical specifications before production shipments.

Samples of parts with the alternate dice are available upon request.

PRODUCTS AFFECTED
See enclosed parts listing.

WEB LINKS
Manufacturer’s Notice: http://www.diodes.com/products/PCNs.shtml
For More Information Contact: http://www.diodes.com/contact/
Data Sheet: http://www.diodes.com/index.php

DISCLAIMER
Unless a Diodes Inc. Sales representative is contacted in writing within 30 days of the posting of this notice, all changes described in this announcement are considered approved.

PCN APPROVAL

<table>
<thead>
<tr>
<th>Signatories</th>
<th>Name</th>
<th>Signature</th>
<th>Date</th>
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<tbody>
<tr>
<td>Signature of Sr. Vice President, Sales &amp; Mktg.</td>
<td>Mark King</td>
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<td>March 11, 2008</td>
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<td>Signature of VP Corporate Administration</td>
<td>Ed Tang</td>
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<td>Signature of VP Product Development</td>
<td>Francis Tang</td>
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<td>March 10, 2008</td>
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